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**LC78632RE** 

**Compact Disk Player DSP** 



## Preliminary

### **Overview**

The LC78632RE is a compact disc D/A signal-processing LSI for Video-CD players that provides a variable clock error correction (VCEC) mode. The LC78632RE demodulates the EFM signal from the optical pickup and performs de-interleaving, error detection, error correction, digital filtering, and other processing. The LC78632RE includes an on-chip 1-bit D/A converter, and executes commands sent from a control microprocessor.

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### **Features**

- VCEC support
- Built-in PLL circuit for EFM detection (supports 4× playback)
- 18KB RAM on chip
- Error detection and correction (corrects two errors in C1 and four errors in C2)
- Frame jitter margin: ±8 frames
- · Frame synchronization signal detection, protection, and insertion
- Dual interpolation adopted in the interpolation circuit.
- · EFM data demodulation
- Subcode demodulation
- · Zero-cross muting adopted
- Servo command interface
- 2fs digital filter
- Digital de-emphasis
- Built-in independent left- and right-channel digital attenuators (239 attenuation steps)
- Supports the bilingual function
- Left/right swap function
- Built-in 1-bit D/A converter (third-order  $\Delta \Sigma$  noise shaper, PWM output)
- Built-in digital output circuit
- CLV servo

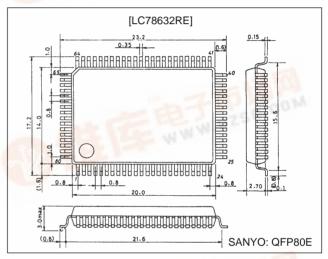
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- Arbitrary track jumping (of up to 255 tracks)
- Variable sled voltage (four levels)
- Six extended I/O ports and 2 extended output ports
- Built-in oscillator circuit using an external 16.9344 MHz or 33.8688 MHz (for 4× playback) element
- Supply voltage: 4.5 to 5.5 V

# Package Dimensions

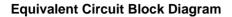
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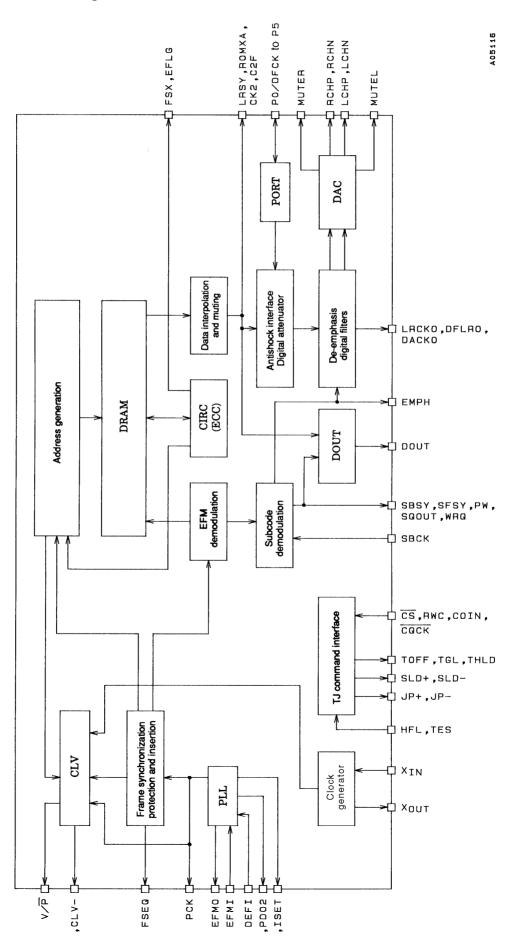
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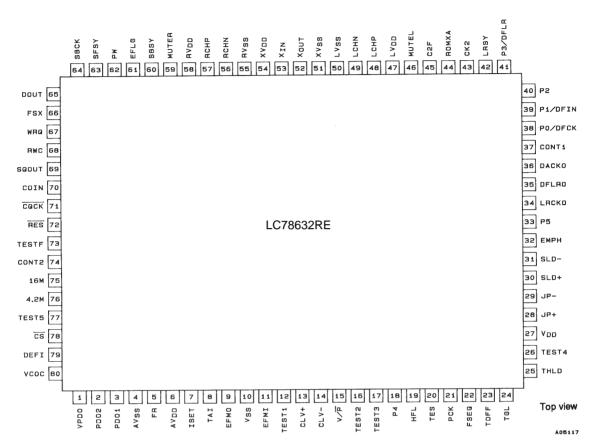
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#### LC78632RE

#### **Pin Assignment**



#### Absolute Maximum Ratings at Ta = $25^{\circ}$ C, V<sub>SS</sub> = 0 V

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V <sub>DD</sub> max		-0.3 to +7.0	V
Input voltage	V <sub>IN</sub>		–0.3 to V <sub>DD</sub> + 0.3	V
Output voltage	V <sub>OUT</sub>		–0.3 to V <sub>DD</sub> + 0.3	V
Allowable power dissipation	Pd max		470	mW
Operating temperature	Topr		-30 to +75	°C
Storage temperature	Tstg		-40 to +125	°C

## Allowable Operating Ranges at Ta = 25°C, $V_{SS}$ = 0 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	V <sub>DD</sub>	$V_{DD}$ , $AV_{DD}$ , $XV_{DD}$ , $LV_{DD}$ , $RV_{DD}$	4.5	5.0	5.5	V
Input high-level voltage	V <sub>IH</sub> 1	$V_{IH1} \begin{array}{c} {\sf TEST1 \ to \ TEST5, \ TAI, \ HFL, \ TES, \ P0/DFCK, \ P1/DFIN, \\ P2, \ P3/DFLR, \ P4, \ P5, \ SBCK, \ RWC, \ COIN, \ \overline{CQCK}, \\ \hline RES, \ \overline{CS}, \ X_{IN}, \ DEFI \end{array}$			V <sub>DD</sub>	V
	V <sub>IH</sub> 2	EFMI	0.6 V <sub>DD</sub>		V <sub>DD</sub>	V
Input low-level voltage	V <sub>IL</sub> 1	TEST1 to TEST5, TAI, HFL, TES, P0/DFCK, P1/DFIN, P2, P3/DFLR, P4, P5, SBCK, RWC, COIN, $\overrightarrow{CQCK}$ , RES, $\overrightarrow{CS}$ , X <sub>IN</sub> , DEFI	0		0.3 V <sub>DD</sub>	V
	V <sub>IL</sub> 2	EFMI	0		0.4 V <sub>DD</sub>	V
Data setup time	t <sub>SU</sub>	COIN, RWC: Figures 1 and 4	400			ns
	t <sub>PRS</sub>	RWC: Figure 4	100			ns
Data hold time	t <sub>HD</sub>	COIN, RWC: Figures 1 and 4	400			ns

#### Continued from preceding page.

Parameter	Symbol	Conditions	min	typ	max	Unit
High-level clock pulse width	t <sub>WH</sub>	SBCK, CQCK: Figures 1, 2, 3, and 4	400			ns
Low-level clock pulse width	t <sub>WL</sub>	SBCK, CQCK: Figures 1, 2, 3, and 4	400			ns
Data read access time	t <sub>RAC</sub>	SQOUT, PW: Figures 2, 3, and 4	0		400	ns
Command transfer time	t <sub>RWC</sub>	RWC: Figures 1 and 4	1000			ns
Subcode Q read enable time	t <sub>SQE</sub>	WRQ: Figure 2, with no RWC signal		11.2		ms
Subcode read cycle	t <sub>SC</sub>	SFSY: Figure 3		136		μs
Subcode read enable	t <sub>SE</sub>	SFSY: Figure 3	400			ns
Port output delay time	t <sub>PD</sub>	CONT1, CONT2, P0 to P5: Figure 5			1200	ns
Input loval	V <sub>EI</sub>	EFMI	1.0			Vp-p
Input level	V <sub>XI</sub>	X <sub>IN</sub> : Capacitance coupled input	1.0			Vp-p

Note: Due to the structure of this IC, the identical voltage must be applied to all power-supply pins.

# Electrical Characteristics at Ta = 25°C, $V_{DD}$ = 5 V, $V_{SS}$ = 0 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Current drain	I <sub>DD</sub>	Normal-speed playback		30		mA
Input high-level current	I <sub>IH</sub> 1	EFMI, HFL, TES, SBCK, RWC, COIN, $\overrightarrow{CQCK}$ , $\overrightarrow{RES}$ , DEFI: V <sub>IN</sub> = 5 V			5	μΑ
	I <sub>IH</sub> 2	TAI, TEST1 to TEST5, $\overline{CS}$ : V <sub>IN</sub> = 5 V	25		75	μA
Input low-level current	I <sub>IL</sub>	TAI, EFMI, HFL, TES, SBCK, RWC, COIN, $\overline{CQCK}$ , $\overline{RES}$ , TEST1 to TEST5, $\overline{CS}$ , DEFI: $V_{IN} = 0 V$	-5			μΑ
	V <sub>OH</sub> 1	EFMO, CLV <sup>+</sup> , CLV <sup>-</sup> , V/ $\overline{P}$ , PCK, FSEQ, TOFF, TGL, THLD, JP <sup>+</sup> , JP <sup>-</sup> , EMPH, EFLG, FSX I <sub>OH</sub> = -1 mA	4			v
Output high-level voltage	V <sub>OH</sub> 2	MUTEL, MUTER, LRCKO, DFLRO, DACKO, P0/DFCK, P1/DFIN, P2, P3/DFLR, P4, P5, LRSY, CK2, ROMXA, C2F, SBSY, PW, SFSY, WRQ, SQOUT, 16M, 4.2M, CONT1, CONT2: $I_{OH} = -0.5$ mA	4			v
	V <sub>OH</sub> 3	VPDO: I <sub>OH</sub> = -1 mA	4.5			V
	V <sub>OH</sub> 4	DOUT: I <sub>OH</sub> = -12 mA	4.5			V
	V <sub>OH</sub> 5	LCHP, RCHP, LCHN, RCHN: I <sub>OH</sub> = -1 mA	3.0		4.5	V
Output low-level voltage	V <sub>OL</sub> 1	EFMO, CLV <sup>+</sup> , CLV <sup>-</sup> , V/ $\overline{P}$ , PCK, FSEQ, TOFF, TGL, THLD, JP <sup>+</sup> , JP <sup>-</sup> , EMPH, EFLG, FSX I <sub>OL</sub> = 1 mA			1	v
	V <sub>OL</sub> 2	MUTEL, MUTER, LRCKO, DFLRO, DACKO, P0/DFCK, P1/DFIN, P2, P3/DFLR, P4, P5, LRSY, CK2, ROMXA, C2F, SBSY, PW, SFSY, WRQ, SQOUT, 16M, 4.2M, CONT1, CONT2: I <sub>OL</sub> = 2 mA			0.4	V
	V <sub>OL</sub> 3	VPDO: I <sub>OL</sub> = 1 mA			0.5	V
	V <sub>OL</sub> 4	DOUT: I <sub>OL</sub> = 12 mA			0.5	V
	V <sub>OL</sub> 5	LCHP, RCHP, LCHN, RCHN: I <sub>OL</sub> = 1 mA	0.5		2.0	V
	I <sub>OFF</sub> 1	PDO1, PDO2, VPDO, P0/DFCK, P1/DFIN, P2, P3/DFLR, P4, P5: V <sub>OUT</sub> = 5 V			5	μΑ
Output off leakage current	I <sub>OFF</sub> 2	PDO1, PDO2, VPDO, P0/DFCK, P1/DFIN, P2, P3/DFLR, P4, P5: V <sub>OUT</sub> = 0 V	-5			μΑ
Charge pump output current	IPDOH	PDO1, PDO2: R <sub>ISET</sub> = 68 kΩ	-96	-80	-64	μA
	IPDOL	PDO1, PDO2: R <sub>ISET</sub> = 68 kΩ	64	80	96	μA
	V <sub>SLD</sub> 1		1.0	1.25	1.5	V
Sled output voltage	V <sub>SLD</sub> 2		2.25	2.5	2.75	V
olog odiput voltage	V <sub>SLD</sub> 3		3.5	3.75	4.0	V
	V <sub>SLD</sub> 4		4.75			V

# D/A Converter Analog Characteristics at $Ta=25^{\circ}C,\,V_{DD}=5$ V, $V_{SS}=0$ V

Parameter	Symbol	Conditions	min	typ	max	Unit
Total harmonic distortion	THD + N	LCHP, LCHN, RCHP, RCHN; 1 kHz: 0 dB input, using a 20-kHz low-pass filter (AD725D built in)		0.006		%
Dynamic range	DR	LCHP, LCHN, RCHP, RCHN; 1 kHz: -60 dB input, using the 20-kHz low-pass filter (A filter (AD725D built in))		90		dB
Signal-to-noise ratio	S/N	LCHP, LCHN, RCHP, RCHN; 1 kHz: 0 dB input, using the 20-kHz low-pass filter (A filter (AD725D built in))	98	100		dB
Crosstalk CT		LCHP, LCHN, RCHP, RCHN; 1 kHz: 0 dB input, using a 20-kHz low-pass filter (AD725D built in)	96	98		dB

Note: Measured in normal-speed playback mode in a Sanyo 1-bit D/A converter block reference circuit, with the digital attenuator set to EE (hexadecimal).

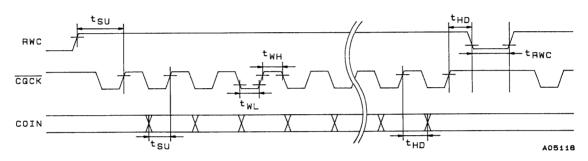


Figure 1 Command Input

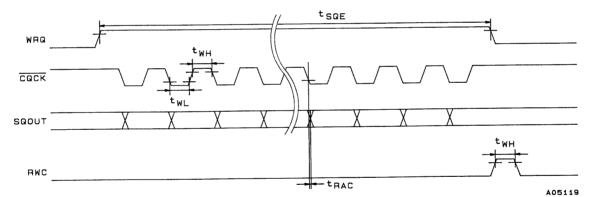


Figure 2 Subcode Q Output

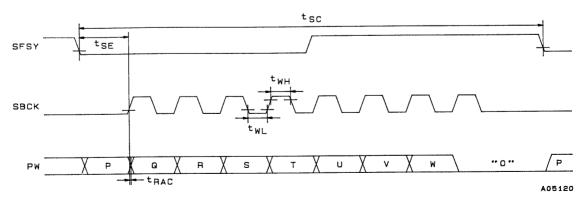
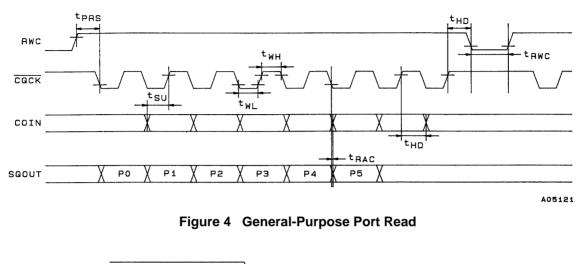


Figure 3 Subcode Output





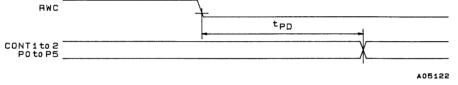
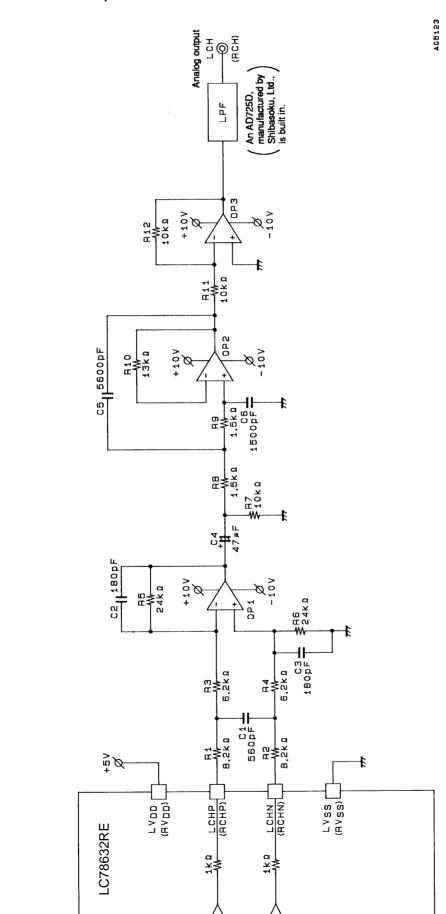


Figure 5 General-Purpose Port Output



One-Bit D/A Converter Output Block Reference Circuit

#### LC78632RE

#### **Pin Functions**

Pin No.	Symbol	I/O		Function			
1	VPDO	0	Test output				
2	PDO2	0	Double-speed and quad-speed mode playback PLL charge pump output. Must be left open if unused.				
3	PDO1	0	Normal-speed mode pla	nyback PLL charge pump output			
4	AV <sub>SS</sub>			Must be connected to 0 V.			
5	FR			range setting resistor connection			
6	AV <sub>DD</sub>		Analog system power su	ly ly			
7	ISET			t current setting resistor connection			
8	TAI	1		resistor is built in. Must be connected to 0 V.			
9	EFMO	0		FM signal output			
10	V <sub>SS</sub>	-		Aust be connected to 0 V.			
11	EFMI	1	EFM signal input				
12	TEST1	1		resistor is built in. Must be connected to 0 V.			
13	CLV+	0					
13	CLV-	0	deceleration.	tput. CLV+ outputs a high level for acceleration, and CLV- outputs a high level for			
14		0		trol automatic switching monitor output. A high-level output indicates rough servo, and a			
15	V/P	0	low-level output indicate				
16	TEST2	I	Test input. A pull-down	resistor is built in. Must be connected to 0 V.			
17	TEST3	I	Test input. A pull-down	resistor is built in. Must be connected to 0 V.			
18	P4	I/O	I/O port				
19	HFL	I	Track detection signal ir	nput. This is a Schmitt input.			
20	TES	I	Tracking error signal inp	out. This is a Schmitt input.			
21	РСК	0	EFM data playback bit c playback.	lock monitor. Outputs 4.3218 MHz when the phase is locked in normal-speed mode			
22	FSEQ	0	Synchronization signal detection output. Outputs a high level when the synchronization signal detected from the EFM signal matches the internally generated synchronization signal.				
23	TOFF	0	Tracking off output				
24	TGL	0	• ·	Tracking gain switching output. Increase the gain when this pin outputs a low level.			
25	THLD	0		racking gain switching output. Increase the gain when this pin outputs a low level.			
26	TEST4	1	- · ·	est input. A pull-down resistor is built in. Must be connected to 0 V.			
27				igital system power supply			
	V <sub>DD</sub>	-		ack jump output. JP+ outputs a high level both for acceleration during outward direction jumps and for			
28 29	JP+	0	deceleration during inwa	eceleration during inward direction jumps. JP <sup>-</sup> outputs a high level both for acceleration during inward direction			
30	SLD+	0	Jumps and for deceleration	nps and for deceleration during outward direction jumps.			
	SLD <sup>-</sup>	0	Sled output. This pin car	ed output. This pin can be set to 1 of 4 levels by commands sent from the system control microprocessor.			
31	EMPH	-	De emphasie meniter A	high lavel indicates that a disk requising de emphasis is heing played			
32		0	•	high level indicates that a disk requiring de-emphasis is being played.			
33	P5	1/0	I/O port				
34	LRCKO	0		LR clock output			
35	DFLRO	0	Digital filter outputs	LR data output. The digital filter can be turned off with the DFOFF command.			
36	DACKO	0		Bit clock output			
37	CONT1	0	Output port				
38	P0/DFCK	I/O	I/O port. DF bit clock inp				
39	P1/DFIN	I/O	I/O port. DF data input in				
40	P2	I/O	I/O port. Used as the de on when this pin is high.	-emphasis filter on/off switching pin in antishock mode. The de-emphasis filter is turned			
41	P3/DFLR	I/O	I/O port output or digital	filter LR clock input (when anti-shock mode)			
42	LRSY	0		LR clock output			
43	CK2	0		Bit clock output. The polarity can be inverted with the CK2CON command.			
44	ROMXA	0	ROMXA pins	Interpolated data output. Data that has not been interpolated can be output by issuing the ROMXA command.			
45	C2F	0	1	C2 flag output			
46	MUTEL	0		Left channel mute output			
40	LV <sub>DD</sub>	Ĕ		Left channel power supply			
47		0		Left channel P output			
48	LCHP	0	One-bit D/A				
49 50			converter pins Left channel N output				
	LV <sub>SS</sub>		Left channel ground. Must be connected to 0V.				

Note: Of the general-purpose I/O ports, any unused input ports must be connected to 0 V, or set to be output ports.

#### Continued from preceding page.

Pin No.	Symbol	I/O	Function				
51	XV <sub>SS</sub>		Crystal oscillator ground. Must be connected to 0 V.				
52	Х <sub>ОИТ</sub>	0					
53	X <sub>IN</sub>	I	16.9344 MHZ Crysta	16.9344 MHz crystal oscillator connections. Use a 33.8688 MHz crystal oscillator for quad-speed playback.			
54	XV <sub>DD</sub>		Crystal oscillator po	Crystal oscillator power supply			
55	RV <sub>SS</sub>			Right channel ground. Must be connected to 0 V.			
56	RCHN	0	]	Right channel N output			
57	RCHP	0	One-bit D/A converter pins	Right channel P output			
58	RV <sub>DD</sub>			Right channel power supply			
59	MUTER	0	]	Right channel mute output			
60	SBSY	0	Subcode block syne	chronization signal output			
61	EFLG	0	C1 and C2 error co	rrection state monitor			
62	PW	0	Subcode P, Q, R, S	Subcode P, Q, R, S, T, U, V, and W output			
63	SFSY	0	Subcode frame syn	Subcode frame synchronization signal output. Falls when the subcode output goes to the standby state.			
64	SBCK	I	Subcode readout cl	Subcode readout clock input. This is a Schmitt input. This pin must be connected to 0 V if unused.			
65	DOUT	0	Digital output	Digital output			
66	FSX	0	Outputs a 7.35 kHz	Outputs a 7.35 kHz synchronization signal generated by dividing the crystal oscillator frequency.			
67	WRQ	0	Subcode Q output s	Subcode Q output standby output			
68	RWC	I	Read/write control i	Read/write control input			
69	SQOUT	0	Subcode Q output	Subcode Q output			
70	COIN	I	Input for commands	s from the control microprocessor			
71	CQCK	I	Command input ac	quisition clock. Also used as the SQOUT subcode readout clock input. This is a Schmitt input			
72	RES	I	Chip reset input. Th	is pin must be set low temporarily when power is first applied.			
73	TESTF	0	Test output				
74	CONT2	0	Output port				
75	16M	0	16.9344 MHz outpu	16.9344 MHz output			
76	4.2M	0	4.2336 MHz output				
77	TEST5	I	Test input. A pull-de	own resistor is built in. Must be connected to 0 V.			
78	CS	I	Chip select input. A	pull-down resistor is built in. When control is not used, this pin must be connected to 0 V.			
79	DEFI	I	Defect detection signal input. Must be connected to 0 V if unused.				
80	VCOC	1	Test input. Must be connected to 0 V.				

Note: Of the general-purpose I/O ports, any unused input ports must be connected to 0 V, or set to be output ports.

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